

# Full Bridge Power Amplifier

## FEATURES

- Dual Power Operational Amplifiers
- $\pm 2A$  Output Current Guaranteed
- Precision Current Sense Amplifier
- Two Supply Monitoring Inputs
- Parking Function and Under-Voltage Lockout
- Safe Operating Area Protection
- 3V to 35V Operation

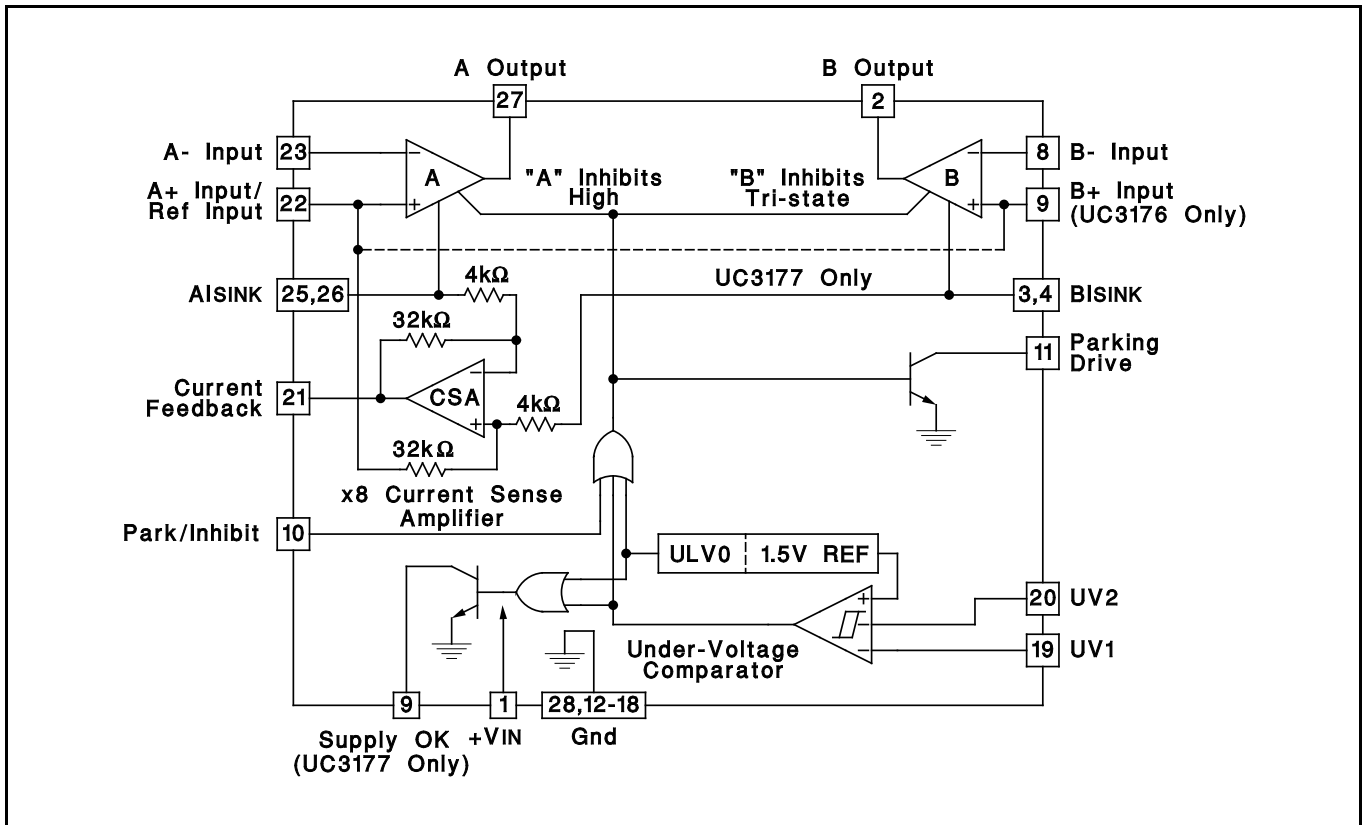
## DESCRIPTION

The UC3176/7 family of full bridge power amplifiers is rated for a continuous output current of 2A. Intended for use in demanding servo applications such as disk head positioning, the onboard current sense amplifier can be used to obtain precision control of load current, or where voltage mode drive is required, a standard voltage feedback scheme can be used. Output stage protection includes foldback current limiting and thermal shut-down, resulting in a very rugged device.

Auxiliary functions on this device include a dual input under-voltage comparator that can be programmed to respond to low voltage conditions on two independent supplies. In response to an under-voltage condition the power Op-Amps are inhibited and a high current, 100mA, open collector drive output is activated. A separate Park/Inhibit command input.

The devices are operational over a 3V to 35V supply range. Internal under-voltage lockout provides predictable power-up and power-down characteristics.

## BLOCK DIAGRAM



### ABSOLUTE MAXIMUM RATINGS (Note 1)

Input Supply voltage, (+VIN) . . . . .	40V
Park/Inhibit, UV1 and UV2 inputs (zener clamped)	
Maximum forced voltage . . . . .	-0.3V to 10V
Maximum forced current. . . . .	±10mA
Other Input Voltages. . . . .	-0.3V to +VIN
AlsINK and BIsINK Voltages . . . . .	-0.3V to 6V
Open Collector Output Voltages. . . . .	40V
A and B Output Currents (Continuous)	
Source . . . . .	Internally Limited
Sink . . . . .	2.5A
Total Supply Current (Continuous). . . . .	4A
Parking Drive Output Current (Continuous). . . . .	200mA
Supply OK Output Current, UC3177 (Continuous) . . . . .	30mA
Operating Junction Temperature . . . . .	-55°C to +150°C
Power Dissipation at TC = +75°C	
QP package. . . . .	4W
Storage Temperature . . . . .	-65°C to +150°C

Note 1: Unless otherwise indicated, voltages are reference to ground and currents are positive into, negative out of, the specified terminals.

### THERMAL DATA

QP package:	
Thermal Resistance Junction to Leads, $\theta_{JL}$ . . . . .	15°C/W
Thermal Resistance Junction to Ambient, $\theta_{JA}$ . . . . .	50°C/W

### CONNECTION DIAGRAM

**PLCC-28 (Top View)  
QP Package**

PACKAGE PIN FUNCTION	
FUNCTION	PIN
+VIN	1
B Output	2
BIsINK(Sense)	3
BIsINK	4
N/C	5-7
B- Input	8
*	9
Park/Inhibit	10
Parking Drive	11
Gnd (Heat Flow Pins)	12-18
UV1	19
UV2	20
Current Feedback	21
A+ Input	22
A- Input	23
N/C	24
AlsINK	25
AlsINK(Sense)	26
A Output	27
Gnd	28

\*Pin 9: UC3176, B+ Input  
UC3177, Supply OK

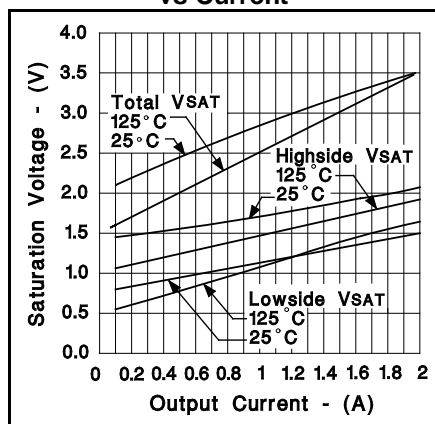
**ELECTRICAL CHARACTERISTICS:** Unless otherwise stated, specifications hold for  $T_A = 0$  to  $70^\circ\text{C}$ ,  $+V_{IN} = 12\text{V}$ ,  $T_A = T_J$ .

PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
<b>Input Supply</b>					
Supply Current	+VIN = 12V		18	25	mA
	+VIN = 35V		21	30	mA
UVOL Threshold	+VIN low to high		2.8	3.0	V
	Threshold Hysteresis		220	300	mV
<b>Power, Amplifier, A and B</b>					
Input Offset Voltage	V <sub>CM</sub> = 6V, V <sub>OUT</sub> = 6V			8	mV
Input Bias Current	V <sub>CM</sub> = 6V, Except A+ Input	-500	-100		nA
Input Bias Current at A+/Reference Input	(A+/Ref - BIsINK)/36kohms; T <sub>J</sub> = 25°C	23	28	35	µA/V
Input Offset Current B Amp (UC3176 Only)	V <sub>CM</sub> = 6V			200	nA
CMRR	V <sub>CM</sub> = 1 to 33V, +VIN = 35V, V <sub>OUT</sub> = 6V	70	100		dB
PSRR	+VIN = 5 to 35V, V <sub>CM</sub> = 2.5V	70	100		dB
Large Signal Voltage Gain	V <sub>OUT</sub> = 3V, w/I <sub>OUT</sub> = 1A to V <sub>OUT</sub> = 9V, w/I <sub>OUT</sub> = -1A	1.5	4		V/mV
Thermal Feedback	+VIN = 20V, Pd = 20W at opposite output		25	200	µV/W
Saturation Voltage	I <sub>OUT</sub> = -2A, High Side, T <sub>J</sub> = 25°		1.9		V
	Cl <sub>OUT</sub> = 2A, Low Side, T <sub>J</sub> = 25°C		1.6		V
	Total V <sub>SAT</sub> at 2A, T <sub>J</sub> = 25°C		3.5	3.7	V
Unity Gain Bandwidth			1		MHz
Slew Rate			1		V/µs
Differential I <sub>OUT</sub> Sense Error Current in Bridge Configuration	I <sub>OUT</sub> (A) = -I <sub>OUT</sub> (B), /I <sub>OUT</sub> - /AlsINK - BIsINK/				
	I <sub>OUT</sub> ≤ 200mA		3.0	6.0	mA
	I <sub>OUT</sub> ≤ 2A		5.0	10	mA
High Side Current Limiting	=VIN - V <sub>OUT</sub> < 12V		-2.7	-2.0	A

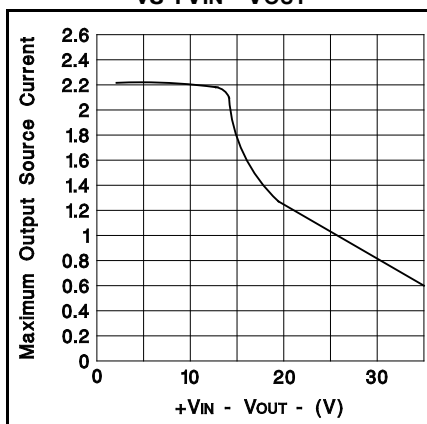
**ELECTRICAL CHARACTERISTICS:** Unless otherwise stated, specifications hold for  $T_A = 0$  to  $70^\circ\text{C}$ ,  $+V_{IN} = 12\text{V}$ ,  $T_A = T_J$ .

PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
<b>Current Sense Amplifier</b>					
Input Offset Voltage	$V_{CM} = 0\text{V}$ , A+/Ref at 6V			3	mV
	Ref = 2V to 20V, $+V_{IN} = 35$ , change with Ref input voltage			600	$\mu\text{V/V}$
Thermal Gradient Sensitivity	$+V_{IN} = 20\text{V}$ , Ref = 10V Pd = 20W @ A or B output		5.0	75	$\mu\text{V/W}$
PSRR	Ref = 2.5V, $+V_{IN} = 5$ to 35V	70	100		dB
Gain	$ A_{ISINK} - B_{ISINK}  \leq 0.5\text{V}$	7.8	8	8.1	V/V
Slew Rate			2		$\text{V}/\mu\text{S}$
3dB Bandwidth			1		MHz
Max Output Current	$I_{SOURCE} = +V_{IN} - V_{OUT} = 0.5\text{V}$	2.5	3.5		mA
Output Saturation Voltage	$I_{SOURCE} = 1.5\text{mA}$ , High Side		0.15	0.30	V
	$I_{SINK} = 5\text{mA}$ , Low Side		1.4	1.7	V
<b>Under-Voltage Comparator</b>					
Threshold Voltage	Low to High, other input at 5V	1.44	1.50	1.56	V
	Threshold Hysteresis	50	70	80	mV
Input Current	Input = 2V, other input at 5V	-2	-0.05		$\mu\text{A}$
Supply OK $V_{SAT}$ (UC3177 Only)	$I_{OUT} = 5\text{mA}$			0.45	V
Supply OK Leakage (UC3177 Only)	$V_{OUT} = 35\text{V}$			5	$\mu\text{A}$
<b>Park/Inhibit</b>					
Park/Inhibit Thld		1.1	1.3	1.7	V
Park/Inhibit Input Current	At threshold		60	100	$\mu\text{A}$
Parking Drive Saturation Voltage	$I_{OUT} = 100\text{mA}$		0.3	0.7	V
Parking Drive Leakage	$V_{OUT} = 35\text{V}$			15	$\mu\text{A}$
<b>Thermal Shutdown</b>					
Shutdown Temperature			165		$^\circ\text{C}$

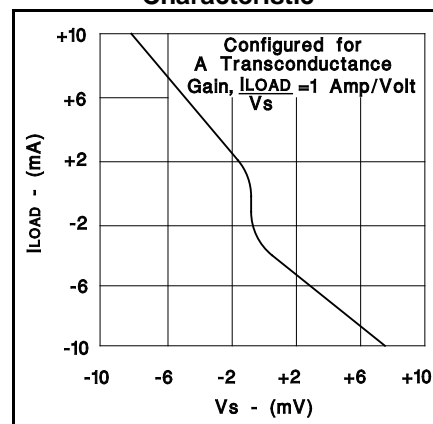
**Output Saturation Voltage vs Current**



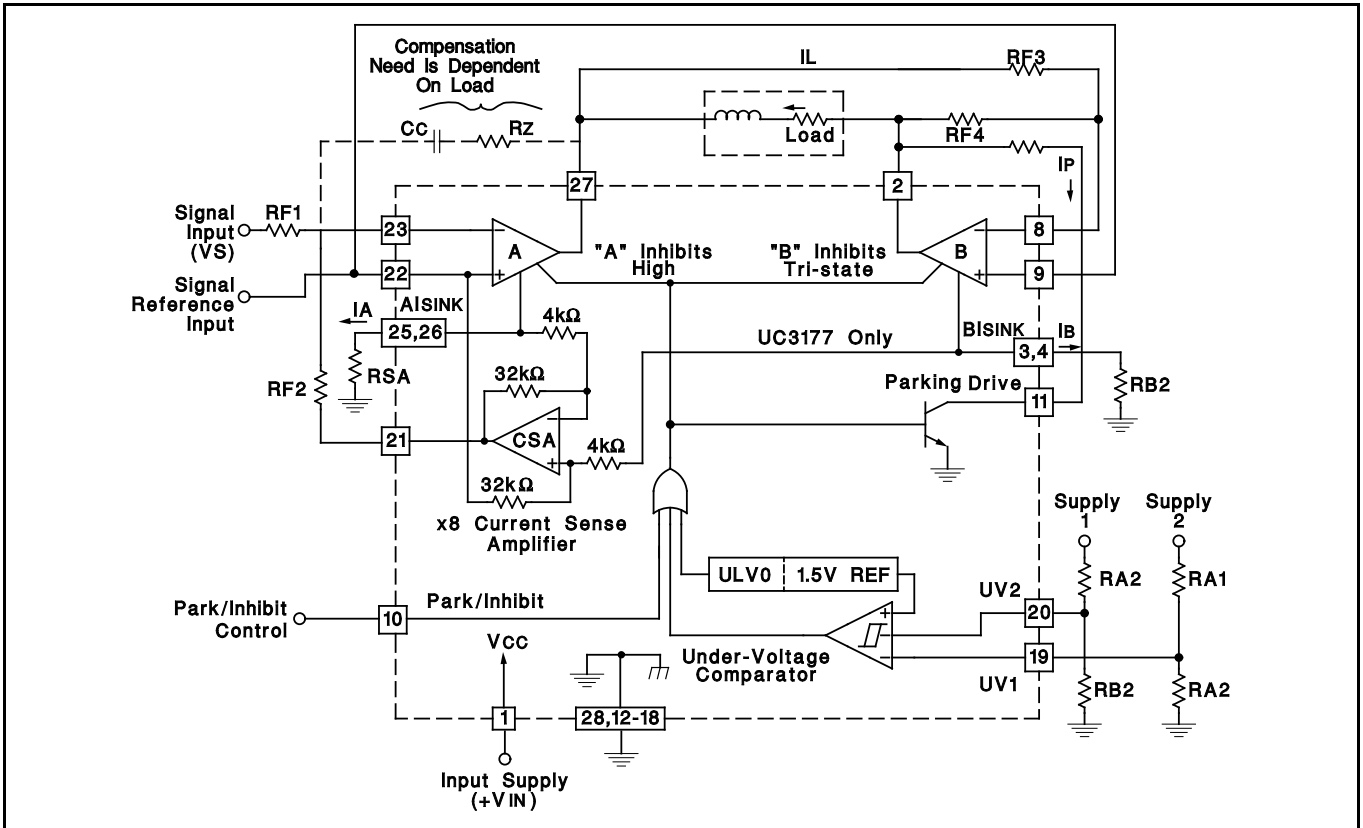
**Maximum Source Current vs  $+V_{IN} - V_{OUT}$**



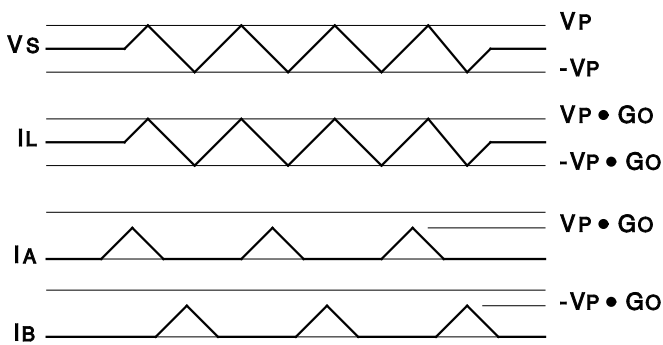
**Crossover Current Error Characteristic**



APPLICATION AND OPERATION INFORMATION



WAVEFORMS FOR ABOVE APPLICATION



DESIGN EQUATIONS

$$\text{Transconductance } (G_O) = \frac{I_L}{V_S} = \frac{R_{F2}}{R_{F1}} \times \left( \frac{1}{8R_S} \right)$$

with:  $R_{SA} = R_{SB}$  and  $R_{F3} = R_{F4}$

$$\text{Parking Current } (I_P) = \frac{V_{IN} - 1.5}{R_P + R_L}$$

where:  $R_L$  = load resistance

Under-Voltage Thresholds, at Supplies  
 High to Low Threshold,  $(V_{LH}) = 1.425 (R_A + R_B)/R_B$   
 Low to High Threshold,  $(V_{HL}) = 1.5 (R_A + R_B)/R_B$

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